PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4018807

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KEI WATANABE	04/18/2016
KAZUSADA TAKEDA	04/18/2016
HIROSHI TAKEZAKI	04/26/2016
KEI MAKITA	04/23/2016
YOSUKE NISHIMURA	04/23/2016

RECEIVING PARTY DATA

Name:	TORAY INDUSTRIES, INC.
Street Address:	1-1, NIHONBASHI-MUROMACHI 2-CHOME
Internal Address:	CHUO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	103-8666

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15120816

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	TIP-16-1258 (308877-560)
NAME OF SUBMITTER:	T. DANIEL CHRISTENBURY
SIGNATURE:	/TDC/
DATE SIGNED:	08/23/2016
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 2
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TIP-16-1258

COMBINED DECLARATION/ASSIGNMENT

WHEREAS, we

Kei Watanabe of Tokai, Japan
Kazusada Takeda of Tokai, Japan
Hiroshi Takezaki of Nagoya, Japan
Kei Makita of Nagoya, Japan
Yosuke Nishimura of Tokai, Japan

(hereinafter referred to as "the undersigned"), have made an invention entitled POLYARYLENE SULFIDE RESIN POWDER/GRAIN COMPOSITION AND METHOD FOR PRODUCING SAME, identified in International Application No. PCT/JP2015/053971, and US Application No. 15/120,816, (DLA Piper is authorized to insert the Serial No. when known),

the above-identified application was made or authorized to be made by the persons executing this Declaration;

we believe that we are the original joint inventors of a claimed invention in the application;

we hereby acknowledge that any willful false statement made in this Declaration is punishable under 18 USC §1001 by fine or imprisonment of not more than five (5) years, or both.

WHEREAS, Toray Industries Inc., with offices at 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo 103-8666 Japan (hereinafter referred to as "assignee"), is desirous of acquiring the entire right, title and interest in said invention, said US application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar ($1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said US application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

EXECUTED on the dates set forth below.

2016. 4. 18
Date

Kei Watanabe
Kei Watanabe

2016. 4. 18
Date

Takeda
Kazusada Takeda

2016. 4. 26
Date

Hiroshi Takezaki
Hiroshi Takezaki

2016. 4. 23
Date

Kei Makita
Kei Makita

2016. 4. 23
Date

Yosuke Nishimura
Yosuke Nishimura